

**CERTIFICATE OF ELECTRONIC
TRANSMISSION**

I hereby certify that this correspondence for Application No. 10/555,713 is being electronically transmitted to Technology Center 2812, via EFS-WEB, on November 30, 2006.

<u>/David H. Brinkman/</u>	11/30/06
David H. Brinkman, Reg. No. 40,532	Date

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):	Martin Hausner et al.
Serial No.:	10/555,713
Filed:	October 20, 2006
Art Unit:	2812
Confirmation No.:	9725
Examiner:	Unknown
Title:	RADIATION SENSOR, WAFER, SENSOR MODULE AND METHOD FOR MANUFACTURING A RADIATION SENSOR (AS AMENDED)
Our Ref. No.:	BEET-14

Cincinnati, OH

November 30, 2006

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SECOND PRELIMINARY AMENDMENT

Sir:

Prior to examination of the above-identified application, please amend the application as follows:

Amendments to the Title begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 9 of this paper.